Assembleon



June 2008

PA 1314/04 Opal-X" - 8 head CL PA 1314/24 Opal-X" - 8 head CLi

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Contents	1.0	Introducing the Opal-X ^{II}
	2.0	General Specifications 5
	3.0	Features, Accessories and Options.103.1 Features.103.2 Accessories and Options.113.3 Machine configuration examples.13
	4.0	Mounting Head Configuration
	5.0	Aligments.185.1 Line Array Camera Aligments185.2 Single Area CCD Aligment205.3 Fiducial Aligment225.4 Master, Bas Mark Sensing24
	6.0	Board Handling
	7.0	Feederbar Exchange System 30 7.1 PA 2505/59 30
	8.0	Component Feeding.328.1 Pneumatic Tape Feeders328.2 Double Shuttle Tray Feeder (PA 2699/24)348.3 Mountable Components & Required Nozzles Opal-X"36
	9.0	Opal-X ^{II} Summary

Contents

2

1.0 Introducing the Opal-X"

The Opal X", part of the Modular High Speed Production Machines, belongs to the X" Series Assembléon' SMD pick & place machines.

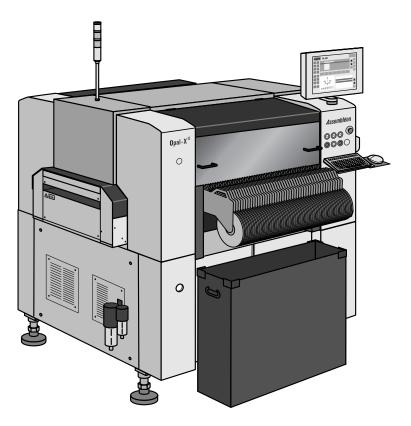


Figure 1 Front view Opal-X"

The Opal-X" is a High Speed flexible machine that can handle a wide range of components at speeds up to 17,700 SMDs per hour. The machine is built around a very rigid, vibrationfree frame for improved accuracy and long-term stability and is perfectly suitable for roundthe-clock production.

The Opal-X^{II} features a high precision single placement beam carrying 8 Super Fine heads with exchangeable nozzles. The placement beam moves in X/Y and Z direction, while the board and component feeders are stationary. A flexible board transport system enables the Opal-X" to handle virtually any type of PCB, with or without tooling pins. Board conveyor width is automatically adjustable, allowing board dimensions up to 460 x 440mm (18" x 17.3") to be handled.

The newly designed vision system with Line Array camera allows fast and accurate "on-thefly" alignment of a wide range of components from 01005 up to 45mm square PLCC, including 45mm square QFPs with lead pitches down to 0.5mm (20 mil). Dark background BGAs, µBGAs and CSPs with ball pitches down to 0.5mm (20 mil) and ball diameters down to 0.3mm (12 mil) can be recognized with the use of new developed illumination unit which allows measurement of ball positions and dimensions.

An optional single area CCD camera extends the component range to 32mm square ICs with lead pitches down to 0.4mm (16 mil). The vision system detects missing, bent or irregular spaced leads or BGA balls; faulty components are rejected.

A separate camera system monitors fiducial marks at the board, circuit and component level, using a combination of white-light and IR LEDs with multi-angle diffusers to provide optimal illumination.

Just six nozzle shapes are required to cover the specified SMD range. High output levels are therefore achieved, as the need for nozzle exchanges is minimal. An optional 20 position nozzle exchange station enables additional special nozzles to be accommodated.

Up to 100 tape feeders can be loaded on the Opal-X". The machine supports tape, stick and trav feeders.

The tape feeder design for the Opal-X" allows simultaneous picking from any mix of tape feeders ranging from 8 to 72mm.

A Windows NT based controller, running an user-friendly Graphical User Interface, allows the Opal-X^{II} to be used stand-alone or in-line. The controller includes a Management Information System (MIS) that continuously gathers production data for management feedback. The unique bad mark sensing capabilities allow a multi-circuit panel to be run as one large board, thus maximizing placement speed while still using bad mark information. A laserbased verification system, which guarantees correct feeder latching, is standard.

The Opal-X" is fully compatible with the other-X" serie machines which use the same feeders, feederbars, software and controller. Off-line feeder changeover can be achieved by using a 20 position Feederbar Exchange System (FES). An entire feederbar can be conveniently loaded off-line, minimizing change-over time.

A basic program optimization function is also included in the machine as standard which can be used during production. For more advanced machine optimization and/or line balancing, the new Production Preparation System allows you to create and optimize SMD machine programs on a PC instead of using the SMD machine.

2.0 General **Specifications**

	Opal-X"	
	· ·	REMARKS
Tact time:	0.20 sec/chip with line array camera	Simultaneous pick with 8 heads
	0.36 sec/SO with line array camera	Simultaneous pick with 4 heads
	1.4 sec/QFP with line array camera	Sequential pick with 4 heads
	1.7 sec/QFP with line array camera	With 1 head
	3.7 sec/QFP with area CCD camera	In fine mode with 1 head
Optimal placement rate:	17,700 cph	Simultaneous pick with 8 heads
		(at best conditions)
IPC 9850 placement rate:	13,900 cph	C0603; all heads, all angles
Nominal placement rate:	11,000 - 13,000 cph	Real mounting time
Applicable Components:	01005 - SOP, SOJ, PLCC 45mm square (1.77")	Line array camera system (45mm)
	6mm-QFP 20mm $\ \ \ \ \ \ \ \ \ \ \ \ \ $	
	20mm-QFP 45mm $\ \ \ \ \ \ \ \ \ \ \ \ \ $	
	Dark background BGA, μBGA, CSP with regular pitches;	
	6mm – 45mm: Min. ball pitch down to 0.50mm (20 mil),	
	Min. ball diameter down to 0.3mm (12 mil)	
	6mm - QFP 32mm ☑(1.26") with pin	Optional 32mm area CCD
	pitch down to 0.4mm (16 mil)	camera system with fore and
	Dark background BGA with regular pitches;	side illumination unit
	6mm - 32mm Ø: Min. ball pitch down to 0.50mm (20 mil),	
	Min .ball diameter down to 0.3mm (12 mil)	
Mounting accuracy (X,Y) 3 σ:	± 50μ for chips 0201 - 0402	Line array camera system
	\pm 75 μ for chips - SOIC	(all placement heads and all
	\pm 60 μ for QFP's (6mm – 45mm \boxtimes with pin pitch down to 0.5mm	placement angles)
	(20 mil))	
	\pm 40 μ for QFP's (6mm- 32mm \square	Optional 32mm area CCD
	(1.26") with pin pitch down to 0.4mm (16 mil))	camera system (in fine mode)
Mounting accuracy (w) 3 σ:	For Chips and SOIC this is Lead dependent	Line array camera system
	\pm 0.2° for QFP's (6mm – 32mm \bowtie	(all placement heads and all
	(1.26") with pin pitch down to 0.5mm (20 mil))	placement angles)
	\pm 0.10° for QFP's (6mm- 32mm \square	Optional area CCD camera
	(1.26") with pin pitch down to 0.4mm (16 mil)	system (in fine mode)
Mounting repeatability 3 σ:	X, Y 30μ for QFPs (6mm - 32mm Z 1.26") pitch 0.4 Phi 0.075°	Optional 32mm area CCD
		camera
Mounting angle:	0 up to 360 (progammable in steps of 0.01)	
Number of heads:	One single beam with 8 standard heads	The Standard heads can
		exchange nozzles with the use
		of the optional Nozzle Exchange
i l		Station

	Opal-X [∥]	
		REMARKS
Alignment system:	One line array camera with fore and side illumination system for	Standard
	Vision on the Fly using the VICS 3200 processing system	
	Area CCD camera for QFP 32mm ☐ (1.26") with pin pitch	Optional
	down to 0.4mm (16 mil)	
	Moving CCD camera for Fiducial alignment	Standard
Type of nozzles for X":	Type 71	Standard for the Opal -X" will
	Type 72	be delivered: 1x nozzle 72,
	Type 73	1x nozzle 73, 1x nozzle 76A,
	Type 75	1x nozzle 74
	Type 76A (Melf nozzle)	
	Type 74	
Nozzle exchange station:	20 nozzle positions	Optional (No nozzles included)
		Nozzle station can hold: 4 x 71,
		4 x 72, 4 x 73A, 2 x 75, 4 x 74,
		1 x 76A and 1 special nozzles
Component weight:	Max: 20 gr.	With the use of Nozzle type 75
Component height:	Max: 6.5mm	Line array camera
	Max: 14 mm (14 over 14 mm)	With the optional area CCD
		camera
Component mounting	Chip: 0.5mm or more	
interdistance:	SOP: 0.7mm or more	
Placement system:	Pneumatic or servo controlled for component height compensation	
Placement force:	24 gram/mm (for nozzles with buffer this value is different)	Pre-tension is 200 gr.
		(spring loaded)
Number of feeders:	Pneumatic Tape Feeders:	
	8mm: 100 positions	
	12mm: 48 positions 16mm: 48 positions	
	24mm: 32 positions	
	32mm: 22 positions	
	44mm: 21 positions	
	56mm: 20 positions	
	72mm: 14 positions	
	Stick feeders: Depends on stick dimensions	
Component Packaging:	Tape according to IEC/EIA-J/JEDEC: 8-72mm	Tape reel diameter max: 380mm (15")

	Opal-X"	
		REMARKS
	Manual Tray feeder: Max. tray size is board width dependent: Max tray size: 330mm x 300mm (12.8" x 11.7") Max tray size by max board width 440mm (17.2"):	Optional: Manual tray feeder Max. number of feeders 75
	330mm x 175mm (12.8" x 6.8") Min tray size: 50mm x 50mm (2.0" x 2.0") Double shuttle LCS Tray Feeder::	Optional: Double shuttle LCS
	tray	
	Max. tray size: 350mm x 440mm (13.7" x 17.2") Min tray size: 50mm x 50mm (2.0" x 2.0")	feeder (no restrictions) Max: 120 Jedec trays
Maximum height pre-mounted components:	Stick and bulk: 6.5mm on placement side (0.26") 18mm on non placement side (0.7")	Many solutions possible Before transport
PCB Dimensions (x,y):	Min: 50 x 50mm (2.0" x 2.0 ") Max: 460 x 440mm (18" x 17.3") Special applications upon request	Using PCB pin fixation
PCB Weight:	Max. 1.2 Kg Max. 2.0 Kg	Without components With components
PCB Thickness:	Min: 0.4mm (0.015") Max: 4.0mm (0.15") Special applications upon request	
Non-mountable area:	Board top side: 3mm from rear side board edge (0.12") 0mm from front side board edge	Component height restrictions apply in the 10mm (0.40") area from front side edge depending on board thickness
	4mm around reference holes (0.16") (locate pins)	Flat edge of 30mm (1.2") is required on bottom right corner for the use of the main stopper, sub and exit stopper
	Board bottom side: 5mm from front and rear side board edge (0.2")	
		For Ceramic PCBs (optional) the non-mountable area can be different.
PCB Material:	Phenolic/FR4/Composite Materials	Ceramic PCB's requires special conveyor section (optional)
PCB positioning:	Locate pin fixation Z servo controlled push up system thickness	Adjustable second pin Software controlled by PCB
	Push up pins	Adjustable positions

	Opal-X ^{II}	
	·	REMARKS
	Board clamping	Optional
	Sub stop (PCB waiting buffer)	Adjustable position
	Exit stop	Fixed position
PCB Transport height:	900mm ± 10mm (35.4" ± 0.4")	Standard
	SMEMA 953mm ± 12.5mm (37.5" ± 0.5")	Standard
PCB Transport direction:	Left to Right	Right to Left is optional
PCB Transport width:	Automatic	Front rail fixed
		Rear rail moving
PCB Loading time:	Approximately 3 sec.	PCB loading concurrent to SMD
		picking and alignment
PCB Ratio width/length:	Max. 1:3	
Control system:	Celeron 566 MHz controller	128Mb intern memory
	Windows NT operating system	
	256 Mb flash disk	
	1.44 Mb floppy drive 3.5"	
	CD-ROM	
	RS 232 Serial Interface + LAN interface	
	15" Color User Interface Monitor	12" Flat/touch screen optional
LAN interface:	Based on IEEE802.3u, IEEE802.3	
Communication protocol:	TCP/IP, NetBEUI	
User Interface	VGOS (Visual Graphical Operating System)	
	Enhanced PC/AT keyboard for data editing functions	
Control system functions:	Max. 127 PCBs	12,800 Components per PCB
	Backup and restoring data using floppy	
	Data conversion Text <> VIOS	
	MIS data gathering	
	Data teaching	
	Data tracing	
	Component database	3000 Component packages; user can define and teach vision files
	Mark database	300 Mark shapes
	SMEMA electrical interface	-15
	On line calibration	
	On line help functions	
	Feeder lock verifier	Optional

	Opal-X"	
	·	REMARKS
Machine dimensions	Length: 1650mm (5.4 ft)	
and weight:	Height: 1850mm (6.1 ft)	
	Width: 1408mm (4.5 ft)	Width including feeders; pneumatic feeders 2244mm (7.36 ft)
	Weight: 1600 kg (3526 Lbs)	
Safety standards:	EN 292, EN 294, EN 349, EN 614, EN 1050, EN 55011, design.	CE-safety is part of system
	EN 50082-1, EN 60204-1 ted	Safety measurements are tes-
	Electrical safety according IEC 204	on each product in the factory.
Warning lights :	White: Emergency stop, safety cover interlock	
	Blue: Error made,e.g. pick up error, out of components Green: In automatic operation	
Audio warning signal	Operational errors	
Electric Power:	Voltage AC: 200/208/220/240/380/400/416 V ± 10%, 3 Phase	More than 3.5mm² cables are needed
	Frequency: 50/60 Hz	
	Consumption: 4.4 kVA max.	
Air supply:	Pressure: > 5.5 .10 ⁵ Pa (5.5 bar, 80 PSI)	
	Quality: dust and oil free	
	Consumption: min.350 NI/min	
Operating Temperature:	15-35P C (59P - 95P F)	Specification guaranteed: 20° - 28° C (68° - 82° F)
Humidity:	20 - 90%, (no dew)	
Noise:	< 78dba	
Clean Room:	Class 10,000 (10 K)	

Table 1

3.0 Features, accessories and options

3.1 **Features**

The standard Opal-X" includes the following features:

- On the fly alignment using a vision system with a Line Array Camera standard equipped with a side illumination unit for BGA's, µBGA, CSP components.
- Placement beam with 8 Super Fine heads.
- · Simultaneous picking is possible by all 8 heads from any mix of tape feeders (except for 01005/0201 components). This allows a much higher nominal placement rate and board throughput.
- Complete component range can be handled with only 6 nozzles shapes.
- Fiducial alignment camera with improved software controlled illumination unit (white + IR Leds), that also can be used as teaching/tracing device and for Bad Mark sensing.
- Automatic width adjustment. The PCB dimension is included in your PCB data.
- PCB pin-positioning. Second pin is easily adjustable for fast changeover.
- PCB push up plate (Z servo controlled) with 12 push up pins, for PCB support. PCB thickness is included in the PCB data.
- Substopper, allowing a second PCB to enter the machine for reducing transport time.
- Exit Substopper, allowing a new PCB to enter the work area of the machine while the downstream machine is still not ready to accept a new PCB.
- 3.5" FDD for backup purposes.
- CD-ROM drive for software installation
- Operation panel with push buttons
- Component dump box.
- · Operator manual, available in different languages.
- User manual.
- Service manual.
- Toolset.
- · First aid spare parts kit.
- CE safety.
- ESD safety.
- Electrical and Mechanical SMEMA.

Standard Software features.

- Variable XY axis speed per component
- Datum angle functionality (especially for stick components, there is no pick angle necessary to recognize the component which results in higher output.)
- User Friendly Graphical Human interface VGOS (Visual-Graphical-Operating-System) with touch screen capability
- An On-line help function allows display of detailed descriptions of operations and functions on screen.
- Management Information System (MIS) to gather production history data.
- 4 point fiducial correction, to maintain accuracy for stretched/distorted boards.
- Template (pattern) matching for PCBs that have no fiducials.
- · Different mark shapes for fiducial pair possible.
- Box teaching to recover fiducial recognition error.
- Data editing functions with the use of the fiducial camera (teaching,tracing).
- A Component database, that can hold up to 3000 component packages, with the most frequently used components already predefined.
- A Mark database, that can hold up to 300 mark shapes, with the most frequently used mark shapes already predefined.
- Precede pick-up, allowing to pick up components before the PCB is fixed, reducing cycle time.
- Alternative feeder function, reducing operator intervention (empty feeder switching).
- Automatic program change over for family boards (self production control).
- Automatic rework cycle to improve operator efficiency and online optimization, to keep mounting speed during production in case of empty feeders. Detected empty feeders are automatically skipped until end off programs, to allow one time replenishment.
- Product preparation can be done on the machine including basic optimization of the mount program. (nozzle and feeder set-up) during production.
- Multi-section PCBs can be either be mounted block-by-block or the block data can be combined to achieve the fastest mounting sequence. In the latter case, block badmarks still remain in effect.

3.2 Accessories and options

	ACCESSORIES AND OPTIONS Opal-X"
PA 1912/00	CSM/GEM Glass Adjustment Kit
PA 2505/26	Board Clamping system Opal-X"
PA 2505/57	Feederbar exchange system front side, including two FES 20 position cart for FV/GEM " series
PA 2505/59	FES (feeder bar exchange) cart 20 positions for " series
PA 2506/36	Flat/touch screen monitor front side
PA 2506/37	Flat/touch screen monitor rear side
PA 2506/38	Rear LCD monitor, keyboard/mouse
PA 2506/35	Operation panel rear side
PA 2506/40	Maintenance lamp
PA 2695/12	Manual Tray Feeder Topaz-X/Emerald-X
PA 2699/24	Double shuttle Tray Feeder (LCS) for Opal-X ^{II}
PA 2903/27	16mm Tapefeeder 15" CL

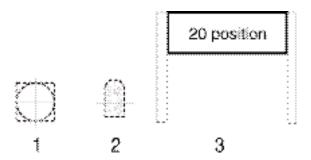
PA 2903/29	16mm Tapefeeder 15" CLi	
PA 2903/38	24mm Tapefeeder 15" CL	
PA 2903/39	24mm Tapefeeder 15" CLi	
PA 2903/48	32mm Tapefeeder 15" CL	
PA 2903/49	32mm Tapefeeder 15" CLi	
PA 2903/58	44mm Tapefeeder 15" CL	
PA 2903/59	44mm Tapefeeder 15" CLi	
PA 2903/67	72mm Tapefeeder 15" CLi	
PA 2903/68	56mm Tapefeeder 15" CL	
PA 2903/69	56mm Tapefeeder 15" CLi	
PA 2903/77	Tapefeeder 8x2 15" CL 0201	
PA 2903/78	Tapefeeder 8x2 15" CL 0402	
PA 2903/79	Tapefeeder 8x4 15" CL	
PA 2903/88	Tapefeeder 12mm 15" FV/GEM CL	
PA 2903/89	Tapefeeder 12mm 15" FV/GEM CLi	
PA 2903/95	Tapefeeder 01005 CLi	
PA 2903/96	Tapefeeder 01005 CL	
PA 2903/97	Tapefeeder 8x2 15" CLi 0201	
PA 2903/98	Tapefeeder 8x2 15" CLi 0402	
PA 2903/99	Tapefeeder 8x4 15" CLi	
9466 920 10921	Reject belt feeder GEM	
PA 2923/00	Set of 20 dummy feeders	
PA 2930/15	Empty tape waste bin (front and rear)	
PA 2932/40	Feeder Floating detection Opal-X ^{II} (front and rear 50 positions	
	feederbar)	
PA 2932/41	Feeder Floating detection Opal-X ^{II} (front for FES20 and rear 50	
,	position fixed feederbar)	
PA 2962/44	Nozzle Type 74 (middle size QFP)	
PA 2962/45	Nozzle Type 73 (1812-SOP/4532-SOP)	
PA 2962/46	Nozzle Type 76A Cylindrical chip (MELF)	
PA 2962/47	Nozzle Type 71 (0201-0402/0603-1005)	
PA 2962/48	Nozzle Type 72 (0603-1206/1608-3216)	
PA 2962/49	Nozzle Type 75 (Large size QFP)	
PA 2963/29	Nozzle Exchange System Opal-X ^{II} (20 position no nozzles included)	
	factory built in only	
PA 2969/85	Area CCD camera 32mm (including fore and side illumination unit)	
	for " series	
PA 2981/15	Pallet for LCS Tray Feeder FV/GEM (PA 2699/22/23/24)	
17, 2004, 10	1 and 101 100 may 1 00001 1 1/ alivi (1 / 2000/22/20/27)	

Table 2

3.3 Machine Configuration Examples

On the following page you can find a machine configuration example for the Opal-X II

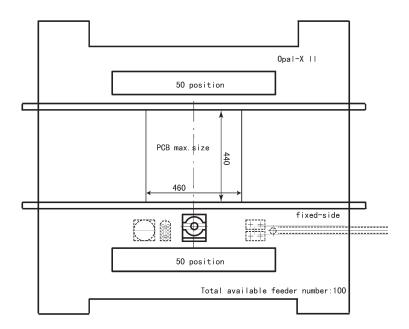
Remark 1: In the example the dotted lines pictures indicate the physical position of the area CCD camera, large component sequencer, nozzle exchange station and FES 20. These can be ordered as an option.



- 1. 32mm Area CCD camera Opal-X^{II}
- 2. Nozzle exchange station for Opal-X^{II}
- 3. Feederbar Exchange System 20 position

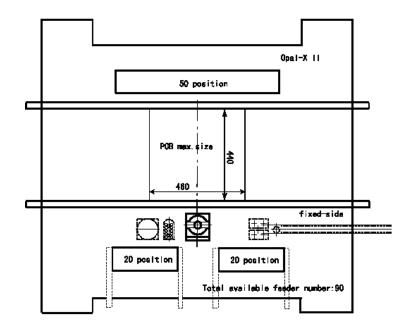
Remark 2: By ordering a Feederbar Exchange System for the front and/or rear side of the machine, the 50 position feederbar will be replaced by two FES 20 position carts.

Example 1: Opal-X"



PA 1314/04	Opal-X ^{II} with 8 SF heads
PA 2505/26	Board clamping for Opal-X ^{II}
PA 2699/24	Double shuttle LCS for Opal-X ^{II}
PA 2932/40	Feeder lock verification system for Opal-X ^{II} (front and rear)
PA 2963/29	Nozzle Exchange System Opal-X ^{II} (18 positions/no nozzles included)
PA 2969/85	Area CCD camera 32mm (including lighting unit) for " series

Example 2: Opal-X^{II}



PA 1314/04 Opal-X" with 8 SF heads
PA 2505/57 Feederbar exchange system front side,
included FES 20 position carts " serie
PA 2505/26 Board clamping for Opal-X"
PA 2699/24 Double shuttle LCS for Opal-X"
PA 2932/40 Feeder lock verification system for Opal-X" (front and rear)
PA 2963/29 Nozzle Exchange System Opal-X" (18 positions/no nozzles included)
PA 2969/85 Area CCD camera 32mm (including lighting unit) for " series

4.0 Mounting Heads Configuration

The Opal-X^{II} features a high precision single placement beam carrying 8 Super Fine heads with exchangeable nozzles. On the head a separate camera system is attached that monitors fiducial marks at the board, circuit and component level, using white + IR light LEDs and multi-angle diffusers to provide optimal illumination. High placement rates are achieved by simultaneous component picking which reduces head beam travel and thus shortens the mounting cycle.

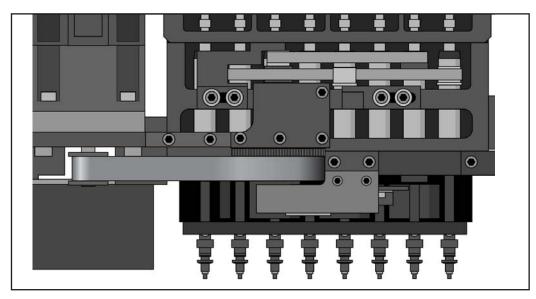


Figure 2 Configuration of head section

The high-precision dual Y drive Opal-X^{II} features four-axis (X,Y,Z,R) servo control for accurate, stress-free component mounting. Direct drive, brushless AC motors controlling heavy duty lead screws allow optimal accuracy and high reliability.

Specifications		
Number of axis:	7	
Axis configuration:	X axis AC servo	
	Double Y axis AC servo	
	Z, R axis AC servo	
	W (automatic width) axis AC servo	
	Push up plate AC servo	
Z axis sequence:	Air and AC servo motor	
R axis sequence:	AC servo motor	
Pick-up error detection:	Vacuum check (256 level digital setting)	
Mounting angle:	0° - 360° (0.01° step)	
Number of mounting head:	8 in-line multi head	
Nozzle types:	6 different shapes	
Encoder resolution:	X,Y = 0.0012mm/pulse	
	Phi = 0.0146° /pulse	
	Z = 0.00048mm/pulse	
Head position accuracy:	X = 0.010mm	
	Y = 0.010mm	
Speed:	X = 1500mm/sec.	
	Y = 1500mm/sec.	
Acceleration:	X = 36600mm/sec ²	
	$Y = 27000 \text{mm/sec}^2$	

Table 3

5.0 Alignment

5.1 Line Array Camera Alignment

The high speed of the Opal-X" is achieved by fast on-the-fly component alignment using a revolutionary Line Array camera system, equipped with a newly developed multi angle illumination unit, that is four times faster than conventional vision systems.

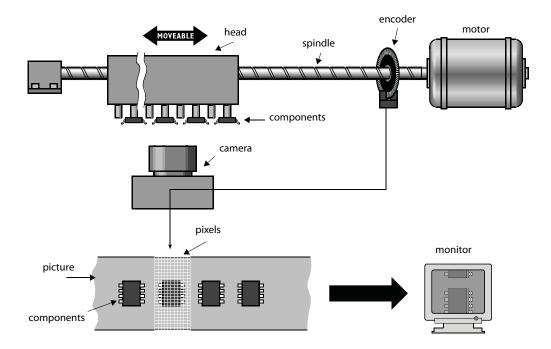


Figure 3 Line sensor vision principle

While moving the beam over the camera, the encoder triggers the camera to capture consecutive lines of pixels. All these lines form the total picture of the components. This picture is processed by a sophisticated vision system. The vision system algorithms inspect the components and calculate position and orientation of the components on the heads.

The SMD components are illuminated by a new developed multi angle side illumination unit which allows high speed recognition of CSP's, μ BGA's. The leads of the components are imaged on the line sensor.

Specif	ications
Line array camera:	CCD 1024 x 1 pixels
Max. component size:	45mm ☑ (1.77")
Min. component size:	01005
Min. lead pitch:	0.5mm (20 mil) > 32mm,
	0.4mm (16 mil) < 32mm
Min. lead width:	0.2mm (0.008")
Grey scale:	256 levels
Lighting:	Multi angle Fore/side illumination (red LED
	array)
	Light intensity is software controlled for each
	component separately
Recognition:	Reflection. Pattern recognition on all leads
Max. number of lead sides:	4
Max. number of lead groups:	2 per side
Check on:	Lead/ball pitch
	Lead/ball location
	Bent/missing leads/balls
	Total number of leads/balls
	Cumulative lead/ball pitch

Table 4

5.2 Single Area CCD alignment

An optional single area CCD camera extends the component range for the Opal- X^{\shortparallel}

Component illumination is performed by means of fore/reflective lighting and side illumination. The lighting source reflects the lead of QFP and the balls of BGA components on the CCD camera. The single area CCD camera grabs the image of the component in one frame and presents it to the vision system for recognition and measurements purposes.

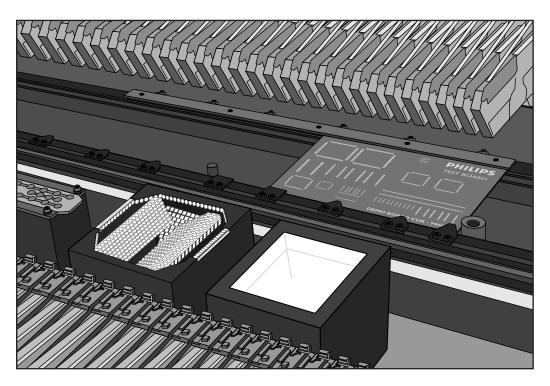


Figure 4 Opal-X" working area

Specifications		
Area CCD camera:	CCD 512 x 480 pixels	
Max. component size:	32mm ☑ (1.26")	
Min. component size:	6mm Ø (0.24")	
Min. lead pitch:	0.4mm (16 mil)	
Min. lead width:	0.2mm (0.008")	
Grey scale:	256 levels	
Lighting:	Fore/side lighting illumination	
Recognition:	Reflection. Pattern recognition on all leads	
Max. number of lead sides:	4	
Max. number of lead groups:	2 per side	
Check on:	Lead/ball pitch	
	Lead/ball location	
	Bent/missing leads/balls	
	Total number of leads/balls	
	Cumulative lead/balls pitch	

Table 5

5.3 **Fiducial** alignment

The Opal-X" is standard equipped with a fiducial camera. This camera is used to compensate for variations in the position of the circuit pattern relative to the expected position. The fiducial alignment system is an opto-electronic system which performs geometric measurements of fiducial marks on the PCB in order to calculate the deviations from their expected positions. The system can use two or four fiducials per board. Each sub-circuit can also be aligned using two fiducials. For placement of fine-pitch components two local fiducials per component may be used. The individual shapes of a fiducial pair can be different to allow for maximum application flexibility. Also pattern recognition algorithms can be used on traces or pads on the PCB board for cases where fiducials are not available. The fiducial camera can also be used as a high accurate teaching device for PCB data (if CAD data is not available), automatic calibration and inspection purposes.

Specifi	cations
Fiducial camera:	CCD
Fiducial camera functionality	Fiducial detection, Bad mark detection,
	teaching device (2 or 4 point teaching)
Fiducial illumination:	White + IR LEDs in conjunction with a wide-
	angle diffuser
Compensation for:	Translation Rotation
(with two fiducials)	Linear stretch and shrink
Compensation for:	Non-linear stretch and shrink
(with 3 or 4 fiducials)	
Type of compensation:	PCB , Block, Local
Fiducial size:	Max. 3.0mm (0.12")
	Min. 0.8mm (0.03")
Fiducial material:	Copper
	Gold
	Lead-tin Lead-tin
Fiducial clearance area:	2 x Fiducial size
PCB warpage at fiducial:	Max. 0.5mm (0.02")
Pattern offset:	Max. 1mm (0.04")
Number of different Fiducial pairs per PCB:	128
Number of Fiducial shapes in Mark Database:	300
Examples of Fiducials:	Solid circle (preferred)
	Square
	Triangle
	Donut
	Binary cross
	Bow-tie (connected)
	Template matching
Fiducial definition:	According CAD data

Table 6

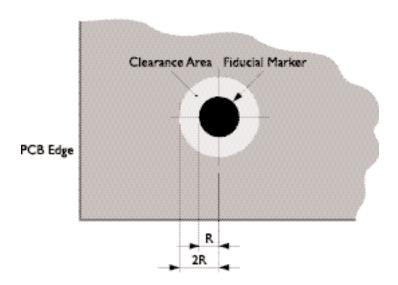


Figure 5 Fiducial free space



* Preferred; others possible but not preferred

Figure 6 Fiducials

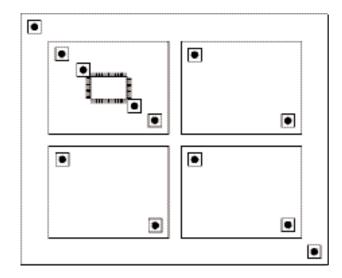


Figure 7 Examples of PCB, block and local fiducials

5.4 Master, Bad Mark Sensing

If the PCB contains sub-circuits, one or more of these subcircuits can be skipped for placement by giving them a "Bad Mark" on a designated position on the subcircuit. No parts will be placed on a circuit that has a Bad Mark. Bad Mark sensing, with the use of the fiducial camera, is based on recognition of a difference in contrast in a certain area. This area can be defined in the machine software (position and area-dimensions). This gives maximum freedom in choosing the process or technique to add Bad Marks, for example:

- · white or light colored labels of any dimension,
- · white paint,
- \dots or any other material that can be fixed as long as it contrast with the PCB surface.

Before checking the Bad Marks on all circuits, the Master Mark may be checked first. Presence of a Master Mark means that one or more Bad Marks are present on the circuits. This allows the machine to skip the Bad Mark sensing process for all circuits if no Bad Marks are located on the circuits, therefore, saving valuable production time.

6.0 Board Handling

PCB boards can be located in the machine by either tooling pins or board clamping if tooling holes are not available. With pin location, one location pin is fixed on the machine while the other locate pin is easily adjustable when the board length changes. Change over to a different board size is just a matter of seconds by using the automatic adjustment (servo controlled) of the conveyor width and the PCB thickness.

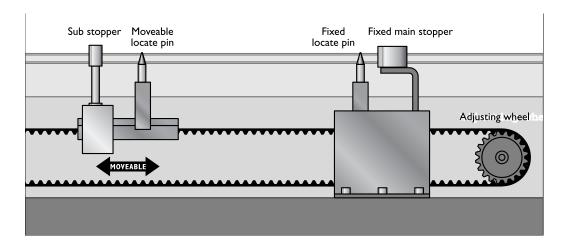


Figure 8 Pin fixation system

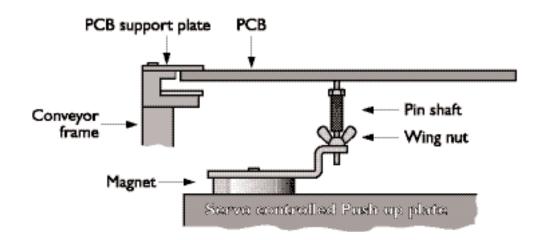


Figure 9 Push up system

A sub-stop enables an additional PCB to enter the machine while the current board is being populated. This reduces time loss during transport and is very useful when operating the machine in a flowline. An exit sub-stop, which can be seen as a transport buffer function, links the entrance sub-stop and main stopper, shortening the PCB transport time and reducing loss from inefficient operation.

When using the machine in a flowline it communicates with the unit upstream and downstream over a SMEMA-connection.

Specif	ications		
PCB Dimensions (x,y):	Min: 50 x 50mm (2.0" x 2.0")		
	Max: 460 x 440mm (18" x 17.3") using PCB		
	pin fixation or PCB board clamping system		
PCB Thickness:	Min: 0.4mm (0.015")		
	Max: 4.0mm (0.15")		
Reference hole position:	5mm (0.2") in X and Y from lower right corner		
Reference hole diameter:	Ø 2.0mm - Ø 4.0mm (0.08" - 0.157")		
PCB Maximum warpage:	0.5mm up (0.02")		
	1.0mm down (0.04")		
Maximum height pre-mounted components:	6.5mm on placement side (0. 26") 18mm on		
	non placement side (0.7")		
Non - Mountable area:	Board Top side:		
	3mm from rear side board edge (0.12")		
	Omm from front side board edge (Component		
	height restrictions apply in the 10mm (0.40")		
	area from front side edge depending on board		
	thickness)		
	4mm around reference holes (0.16") (locate		
	pins)		
	Board Bottom side:		
	5mm from front and rear side board edge		
	(0.2")		
PCB Material:	Phenolic/FR4/Composite Materials		
	Ceramic PCB transport is optional		
PCB weight:	Max. 1.2 Kg without components		
	Max. 2.0 Kg with components		

PCB positioning:	Locate pin fixation (adjustable second pin)
	Z servo controlled push up system (software
	controlled by PCB thickness)
	Push up pins (adjustable positions)
	Optional Board clamping (sandwich)
	Sub stop (PCB waiting buffer) adjustable
	position
	Exit stop (fixed position)
PCB Transport height:	900mm ± 10mm (35.4" ± 0.4")
	SMEMA 953mm ± 12.5mm (37.5" ± 0.5")
PCB Transport direction:	Left to Right standard, optional Right to Left
PCB Transport width:	Automatic
PCB loading time:	Approximately 3 sec.
PCB ratio width/length	Max. 1:3

Table 7

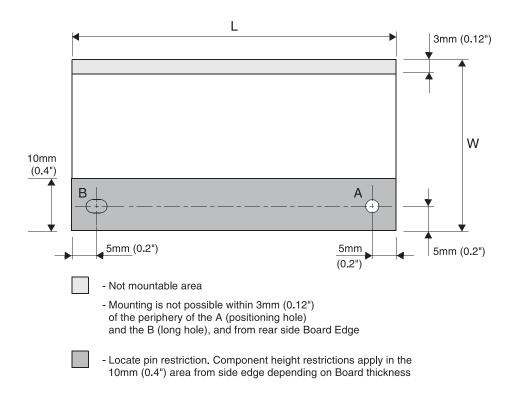


Figure 10 Mountable area

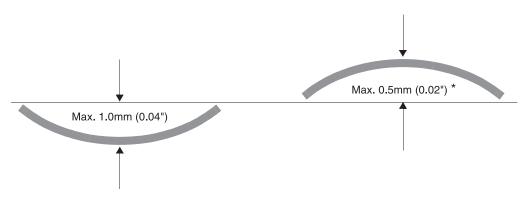


Figure 11 Warp of fixed PCB

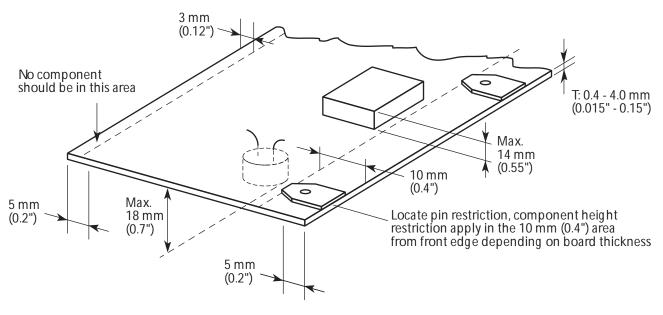


Figure 12 Mountable area

7.0 Feederbar Exchange System

7.1 PA 2505/59

The Feederbar Exchange System (FES) allows fast change-over by switching the complete 20 position feederbar on an Opal-X".

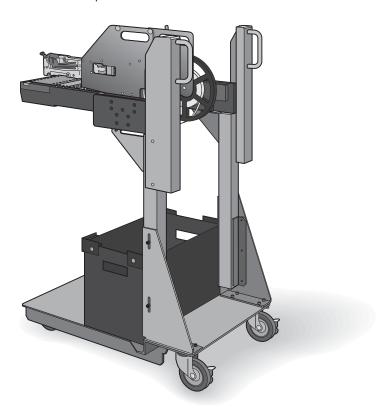


Figure 13 FES-cart X

Feederbars are mounted on carts to off-line feeder Set-up. These carts are easily moved from set-up area to the mounting machines and back. This option is available for the front (PA 2505/57) side of the machine. At the front side of the machine the standard 50 position feederbar will be replaced by two FES 20 position carts.

The Opal-X^{II} FES carts are compatible with those of the X^{II} serie machines. An empty tape bin will be delivered with each FES cart.

FES 20 specifications				
PA 2505/59				
FES change over time:	< 60 sec.			
FES repeatability:	Pick position ≤ 0.05mm			
Applicable feeders:	Tape, stick, bulk feeders			

Number of feeders on FES carriage:	8mm: 20 positions		
	12/16mm: 9 positions		
	24mm: 6 positions		
	32mm: 6 positions		
	44mm: 4 positions		
	56mm: 4 positions		
	Stick: depends on stick dimensions		
Air and Electrical interface:	Quick coupling (one action)		
Electrical power:	Supplied by main system		
Air supply:	Supplied by main system		
FES 20 dimensions, stand alone without feeders:	: Length: 750mm (2.5 ft)		
	Width: 460mm (1.5 ft)		
	Height: 1000mm (3.3 ft)		
Weight without feeders:	65 kg (143 Lbs)		
Tape waste bin :	Included		
Compatibility:	X ^{II} serie machines		
Min. component size:	0402 (1.0mm x 0.5mm)		
	Smaller components should be used with		
	pick-up teaching function.		

Table 8

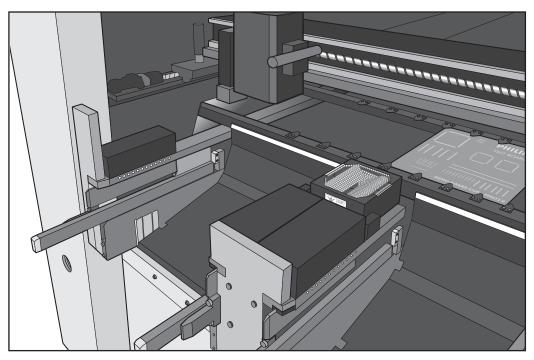


Figure 14 Clamping system

8.0 Component Feeding

8.1 Smart Feeders CLi

Depending on the machine configuration up to 100 Smart Feeders CLi (8mm) can be loaded. The smart feeders are equipped with the latest RFID technology to speed up and simplify machine setup, and to provide a real-time component inventory check. To use this RFID technology, the main machine must be equipped with CLi feederbars.

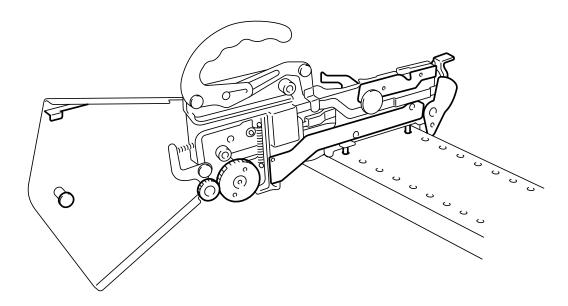


Figure 15 Pneumatic tape feeder

Available CLi tapefeeders					
TAPE FEEDER FEEDING PITCH (MM) PA#					
Tape Feeder 8mm 15" for 01005 CLi	2	PA 2903/95			
Tape Feeder 8mm 15" for 0603 (0201) CLi	2	PA 2903/97			
Tape Feeder 8mm 15" for 1005 (0402) CLi	2	PA 2903/98			
Tape Feeder 8mm 15" CLi	4	PA 2903/99			
Tape Feeder 12mm 15"CLi	4,8,12	PA 2903/89			
Tape Feeder 16mm 15"CLi	4,8,12,16	PA 2903/29			
Tape Feeder 24mm 15"CLi	4,8,12,16,20	PA 2903/39			
Tape Feeder 32mm 15"CLi	8,12,16,20,24,28,32	PA 2903/49			
Tape Feeder 44mm 15"CLi	8,12,16,20,24,28,32,36	PA 2903/59			
Tape Feeder 56mm 15"CLi	8,12,16,20,24,28,32,36	PA 2903/69			
Tape Feeder 72mm 15" CLi	8,12,16,20,24,28,32,36	PA 2903/67			

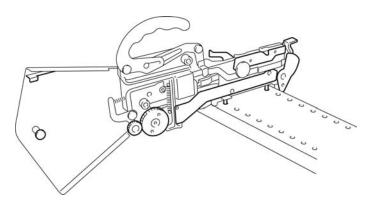
Table 9 The feeding pitch can be adjusted on the feeder side.

Feeder occupation CL and CLi			
Tape feeder 8mm	1		
Tape feeder 12mm, 16mm, 24mm	2-3		
Tape feeder 32mm	4		
Tape feeder 44mm	5		
Tape feeder 56mm	6		
Tape feeder 72mm	7		

Table 10

The above feeder conversion number may differ according to the installation combination.

The Opal-X" comes standard with pneumatic CL feeders which are compatible with all existing GEM models. Depending on the machine configuration up to 100 tape feeders (8mm) can be loaded. The tape feeder design allows simultaneous picking from any mix of tape feeders ranging from 8 to 56mm. To achieve high speed feeding all feeder types are air driven. To prevent incorrect feeder latching, a laser-based verification system is used.



Pneumatic Tape feeder

Figure 16

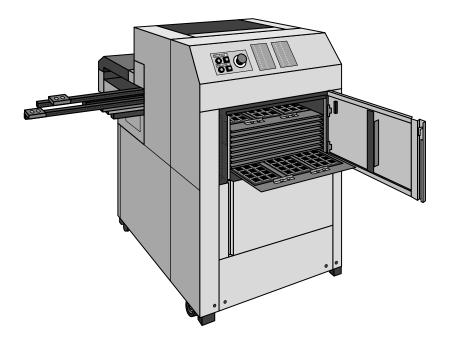
Available CL tapefeeder					
TAPE FEEDER FEEDING PITCH (MM) PA#					
Tape Feeder 8mm 15" for 01005 CL	2	PA 2903/96			
Tape Feeder 8mm 15" for 0603 (0201)	2	PA 2903/77			
component CL					
Tape Feeder 8mm 15" for 1005 (0402) CL	2	PA 2903/78			
Tape Feeder 8mm 15" CL	4	PA 2903/79			
Tape Feeder 12mm 15"CL	4,8,12	PA 2903/88			
Tape Feeder 16mm 15"CL	4,8,12,16	PA 2903/27			
Tape Feeder 24mm 15"CL	4,8,12,16,20	PA 2903/38			
Tape Feeder 32mm 15"CL	8,12,16,20,24,28,32	PA 2903/41			
Tape Feeder 44mm 15"CL	8,12,16,20,24,28,32,36	PA 2903/51			
Tape Feeder 56mm 15"CL	8,12,16,20,24,28,32,36	PA 2903/68			
For larger and special tape feeders such as					
72mm please contact your local sales					
representative					

The feeding pitch can be adjusted on the feeder side

Table 10

8.2 **Double** shuttle Trav Feeder (PA 2699/24)

The double shuttle Tray feeder is an additional pallet sequencer feeding parts from a tray. This feeder can be equipped with maximum 40 pallets, each being able to hold different trays.



Double shuttle tray feeder Figure 17

Two components are picked up from the tray with a double head, and placed simultaneously on a shuttle. This shuttle then moves into the machine where the components are picked by the placement head. The part is then aligned by vision and placed on the PCB. At the same moment when the components are picked by the placement head a second shuttle will be supplied with the next components which minimize the feeding time.

The component feeding time of the double shuttle Tray feeder is 3.5 seconds for 2 parts when using the same tray (pallet 1) and 8.5 seconds when changing the tray (pallet 40). However, in practice no time is lost because of the simultaneous operation of Tray sequencer and Opal-X": while the machine is picking from on-board feeders, the shuttle brings in new components. A part that is rejected by vision will be placed back on the reject conveyor which means no loss of expensive parts.

The PCB conveyor on the double shuttle Tray feeder offers the possibility for visual PCB inspection.

- · A tray container is fixed and separated into two sections with each 20 pallets. This allows tray replenishment while the machine is running.
- A buffer conveyor is standard equipped, so a reflow oven can be connected without additional conveyors.

LCS Tray feeder specifications			
	ERAL		
Max. Tray size (L x W):	350mm x 468mm (13.7" x 18.4") which can		
	hold 3 Jedec trays		
Min. Tray size (L x W):	50mm x 50mm (2.0" x 2.0")		
Component feeding time:	3.5 sec. for 2 parts (picking from pallet 1)		
	8.5 sec. for 2 parts (picking one from pallet 1		
	and one from pallet 40)		
Power and air supply:	Delivered by Opal-X ^{II}		
LCS Tray feeder dimensions :	Length: 826mm (2.8 ft)		
	Height: 1165mm (3.8 ft)		
	(with top cover open 1545mm (5.2 ft))		
	Width: 1650mm (5.2 ft)		
	(with door open 2292mm (7.6 ft))		
Opal-X" + Tray feeder dimensions:	Length: 2476mm (8.3 ft)		
	Height: 1850mm (6.1 ft)		
	Width: 1898mm (6.3 ft) (with LCS door open		
	and		
	feeders on Opal-X ^{II} (2942mm (9.8 ft)		
Weight:	± 280 kg (617 Lbs)		
Power supply, air supply:	Supplied from main machine		
APPLICABLE (COMPONENTS		
Min. Component dimension:	8mm x 8mm (0.31" x 0.31") Mold size		
Max. Component dimension:	45mm x 45mm (1.8" x 1.8")		
Max. Tray height included component height:	8.5mm (0.33") from pallets at pitch of 12.5mm		
	(0.5"), total 40 pallets possible		
	20mm (0.78") from pallets at pitch of 25mm		
	(0.98"), total 20 pallets possible		
FEED C	APACITY		
Number of shuttles:	2		
Number of pads on each shuttle:	2 (with a pitch of 48mm)		
STANDARD COME	PONENT CAPACITY		
Max. number of component types:	120 (3 x 40 Jedec)		
Number of pallets:	Standard 40 pallets included (additional pallets		
	available PA 2981/15)		

Table 11

8.3 Component Feeding

Just six nozzle shapes are required to cover the specified SMD range. High output levels are therefore achieved, as the need for nozzle exchanges is minimal. An optional 20 position nozzle exchange station enables additional special nozzles to be accommodated.

Components		Dimension (mrn)		Required nozzle type	
		L	W	Т	SF
	Solid resistor	0,60	0,30	0,25	71
TT		1,00	0,50	0,50	71
		1,60	0,80	0,50	72
W > C		2,00	1,25	0,50	72
		3,20	1,60	0,60	72
L	Solid resistor	2,00	Ø 1.25		72
Ø (() () () () () () () () ()		3,45	Ø 1.35		72
		5,9	Ø 2.2		72
	Multi-Layered ceramic	0,6	0,3	0,3	71
	capacitor	1,0	0,5	0,5	71
		1,50	0,80	0,80	72
W		2,00	1,25	1,25	72
,,, ,		3,20	1,60	1,25	72
		3.20~4.50	2.50~3.20	1.50~1.90	73
		5,60	5,00	1,90	73
L L	MELF ceramic	3,40	Ø 1.50		73
ø	capacitor	5,9	Ø 2.2		76A
	Tantalium electrolytic	2,90	1,60	1,60	72
T	capacitor	3,80	2,90	1,60	73
		4,70	2,60	2,10	73
W > L		6,00	3,20	2,50	73
		7,30	4,30	2,80	73
	Aluminium electrolytic	4,3	4,3	5,7	73
	capacitor	6,6	6,6	5,7	73
W		10	10	10,5	74

Co	omponents		Dimension (nm)	Required nozzle type
		L	W	T	SF
W L	Chip film capacitor	7,3	5,3	3,25	73
	Chip inductor	3,2	2,5	2,0	73
W		4,5	3,2	3,2	73
T	Semi-variable resistor	4,5	3,8	2,4	73
	Transistor (SOT)	2,90	1,5	1,10	72
T W		4,0	3	1,8	73
T L	Power transistor	4,6	2,6	1,6	73
	SOP (6~28 pin)	5,00	4,50	1,50	73
> < W		7,60	4,50	1,50	73
L		10,10	4,50	1,50	73
TESTER		12,60	5,70	1,50	73
		15,30	7,50	2,00	74
		17,80	7,50	2,00	74
	PLCC	☑ 5~16		73	
		☑ 15~20		74	
" THE STATE OF THE		☑ 15~32			74
		☑ 15~45			75
_	QFP	⊿5~16			74
		☑ 15~20			74
Management and the second		☑ 15~32			74
		☑ 15~45			75
	BGA	10~26			74
		10~30			74
		10~45			75

Co	Components		imension (mr	Required nozzle type	
		L	W	T	SF
	SOJ (20~42 pin)	☑ 10~20			73
THE THEORY		□ 15~30			74
	TSOP (20~32 pin)	⊿10~20			73
		⊿15~30			74

For your information on CSP, μ BGA, bare chip and other types of components, please Table 12 consult your local sales representative.

9.0 Opal-X" Summary

	Model	Opal-XII
	PA number	PA 1314/04
Head	Super Fine head 8 x SF	•
	Nozzle Exchange station 20 position	0
	Special order nozzles	*
Recog- nition sys- tem	Line Array camera 45mm	•
		0
	Fiducial camera	•
Feeding	Pneumatic Tape Feeder	•
	Stick Feeder	0
	Double Shuttle Tray Feeder (LCS)	0
	Reject station	0
	Manual Tray Feeder	0
	Feeder Exchange System (FES 20)	0
sport	Main Stopper	•
	Locate Pin	•
	Board Clamp System	0
an	Z servo controlled Push Up Plate	•
/t	Entrance Sub Stopper	•
ing	Exit Sub Stopper	•
<u>o</u>	Automatic Width Adjustment	•
PCB positioning/transport	High Speed soft-stop conveyor	•
	Reverse transfer Right to Left	0
	Ceramic PCBs	0
	Special sized PCBs	*
Safety	Feeder Floating Detection	0
	Conveyor Entrance/Exit covers	•
	Safety cover for feeder exchange	•
	Dummy Feeders	•
	Safety specifications according CE standards	•
	Spare parts kit + tools	•
	SMEMA kit	•
	Front and rear anti-static covers	•
	Signal tower + warning buzzer	•
Software	Windows NT Graphical User interface	•
	Multiple Accuracy Compensation System	•
	Fiducial Recovery function	•
	Bad Mark / Master Mark Sensing	•
	On-line teaching	•
	Alternative Feeder Function	•
	Automatic program change	•
	Variable XY axis speed per component	•
	On-line Help function	•
	Management Information System	•
	Template (pattern matching)	•
	Automatic rework cycle	•
	On-line data generator	•

Table 13

• = Standard

○ = Optional

* = Special order

Onal-X ^{II}	Summary
Opai-A	Julillialy